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Bib Data Sheet

<b>SERIAL NUMBER</b> 09/594,502	<b>FILING DATE</b> 06/16/2000 <b>RULE</b> _	<b>CLASS</b> 451	<b>GROUP ART UNIT</b> 3723	<b>ATTORNEY DOCKET NO.</b> 47408-20007.00	
<b>APPLICANTS</b> Tomohiro Hashii, Imari-shi, JAPAN; <b>** CONTINUING DATA *****</b> <b>** FOREIGN APPLICATIONS *****</b> JAPAN 11-170860 06/17/1999 <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 08/28/2000</b> _					
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged _____ Examiner's Signature Initials		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 1	<b>TOTAL CLAIMS</b> 3	<b>INDEPENDENT CLAIMS</b> 1
<b>ADDRESS</b> Morrison & Foerster LLP 2000 Pwennsylvania Avenue N W Washington ,DC 20006-1888					
<b>TITLE</b> Semiconductor wafer grinding method					
<b>FILING FEE RECEIVED</b> 820	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		



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CONFIRMATION NO. 1912

<b>SERIAL NUMBER</b> 09/594,502	<b>FILING DATE</b> 06/16/2000 <b>RULE</b>	<b>CLASS</b> 451	<b>GROUP ART UNIT</b> 3723	<b>ATTORNEY DOCKET NO.</b> 47408-20007.00	
<b>APPLICANTS</b> Tomohiro Hashii, Imari-shi, JAPAN; <b>** CONTINUING DATA *****</b> <b>** FOREIGN APPLICATIONS *****</b> JAPAN 11-170860 06/17/1999 <b>IF REQUIRED, FOREIGN FILING LICENSE GRANTED</b> <b>** 08/28/2000</b>					
Foreign Priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged _____ Examiner's Signature Initials		<b>STATE OR COUNTRY</b> JAPAN	<b>SHEETS DRAWING</b> 1	<b>TOTAL CLAIMS</b> 3	<b>INDEPENDENT CLAIMS</b> 1
<b>ADDRESS</b> 25227					
<b>TITLE</b> Semiconductor wafer grinding method					
<b>FILING FEE RECEIVED</b> 820	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		